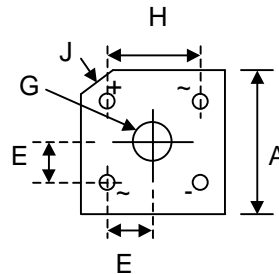
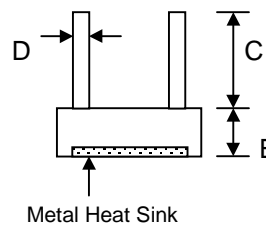


Features

- Diffused Junction
- High Current Capability
- High Case Dielectric Strength
- High Surge Current Capability
- Ideal for Printed Circuit Board Application
- Plastic Material has Underwriters Laboratory Flammability Classification 94V-O



MP-10		
Dim	Min	Max
A	14.73	15.75
B	5.80	6.90
C	19.00	—
D	1.00 Ø Typical	
E	5.11	6.14
G	Hole for #6 screw	
	3.60	4.00
H	10.30	11.30
J	2.38 x 45° Typical	
All Dimensions in mm		



Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Marked on Body
- Weight: 5.4 grams (approx.)
- Mounting Position: Through Hole for #6 Screw
- Mounting Torque: 5.0 Inch-pounds Maximum
- Marking: Type Number

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	MP 1000	MP 1001	MP 1002	MP 1004	MP 1006	MP 1008	MP 1010	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWV} V_R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1) @ $T_A = 50^\circ\text{C}$	I_O	10							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	200							A
Forward Voltage (per element) @ $I_F = 5.0\text{A}$	V_{FM}	1.1							V
Peak Reverse Current @ $T_C = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_C = 100^\circ\text{C}$	I_R	10 1.0							μA mA
I^2t Rating for Fusing ($t < 8.3\text{ms}$) (Note 2)	I^2t	64							A^2s
Typical Junction Capacitance (Note 3)	C_j	110							pF
Typical Thermal Resistance (Note 4)	$R_{\theta JC}$	7.5							K/W
Operating and Storage Temperature Range	T_j, T_{STG}	-65 to +125							$^\circ\text{C}$

- Note: 1. Mounted on heatsink.
 2. Non-repetitive, for $t > 1\text{ms}$ and $< 8.3\text{ms}$.
 3. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.
 4. Thermal resistance junction to case per element.

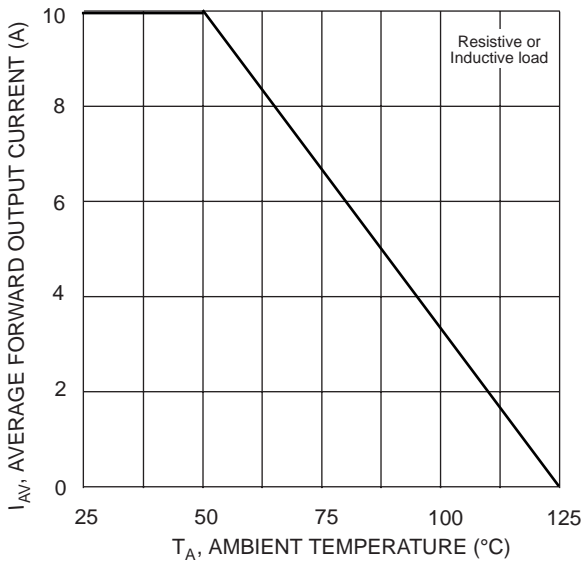


Fig. 1 Forward Current Derating Curve

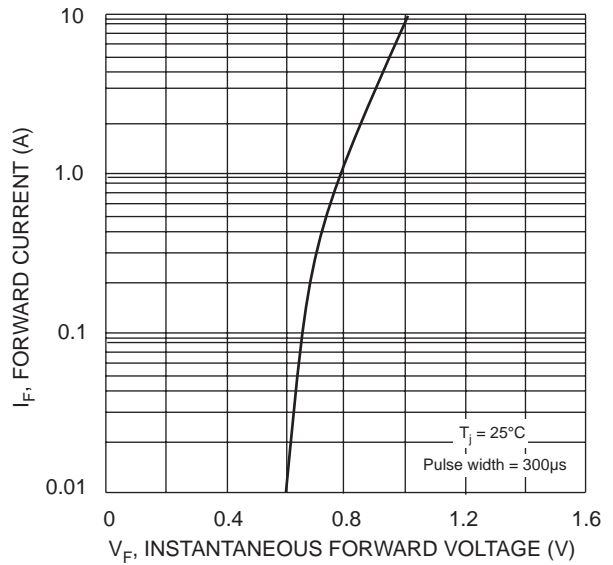


Fig. 2 Typical Forward Characteristics, per element

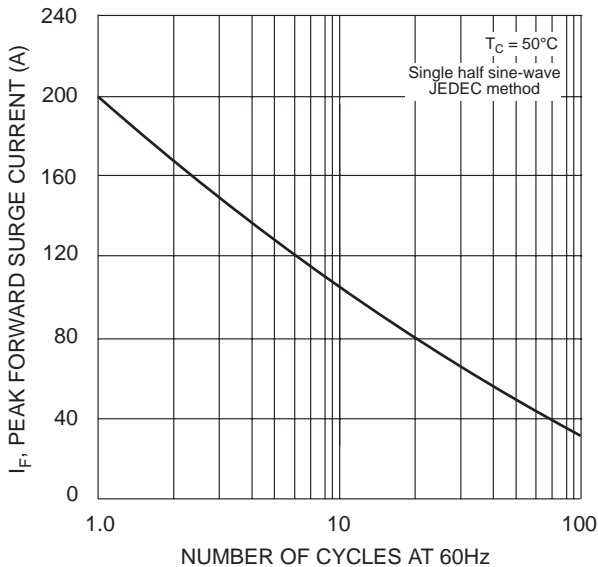


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

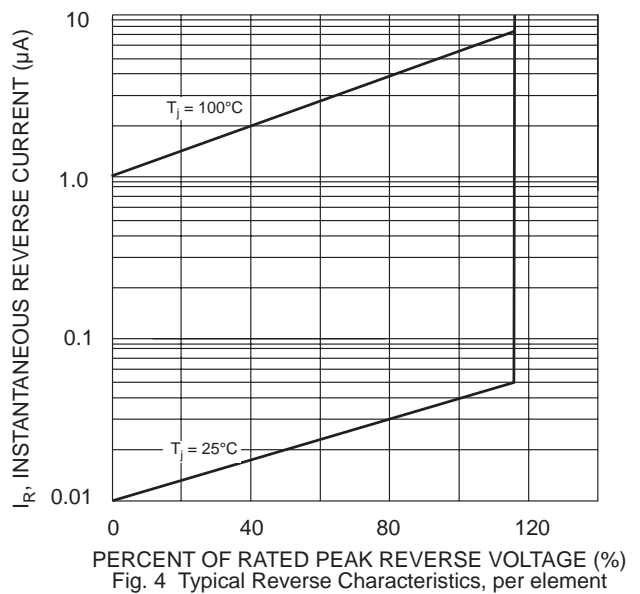


Fig. 4 Typical Reverse Characteristics, per element

ORDERING INFORMATION

Product No.	Package Type	Shipping Quantity
MP1000	Square Bridge	200 Units/Box
MP1001	Square Bridge	200 Units/Box
MP1002	Square Bridge	200 Units/Box
MP1004	Square Bridge	200 Units/Box
MP1006	Square Bridge	200 Units/Box
MP1008	Square Bridge	200 Units/Box
MP1010	Square Bridge	200 Units/Box

Shipping quantity given is for minimum packing quantity only. For minimum order quantity, please consult the Sales Department.

Won-Top Electronics Co., Ltd (WTE) has checked all information carefully and believes it to be correct and accurate. However, WTE cannot assume any responsibility for inaccuracies. Furthermore, this information does not give the purchaser of semiconductor devices any license under patent rights to manufacturer. WTE reserves the right to change any or all information herein without further notice.

WARNING: DO NOT USE IN LIFE SUPPORT EQUIPMENT. WTE power semiconductor products are not authorized for use as critical components in life support devices or systems without the express written approval.

Won-Top Electronics Co., Ltd.

No. 44 Yu Kang North 3rd Road, Chine Chen Dist., Kaohsiung, Taiwan

Phone: 886-7-822-5408 or 886-7-822-5410

Fax: 886-7-822-5417

Email: sales@wontop.com

Internet: <http://www.wontop.com>

We power your everyday.